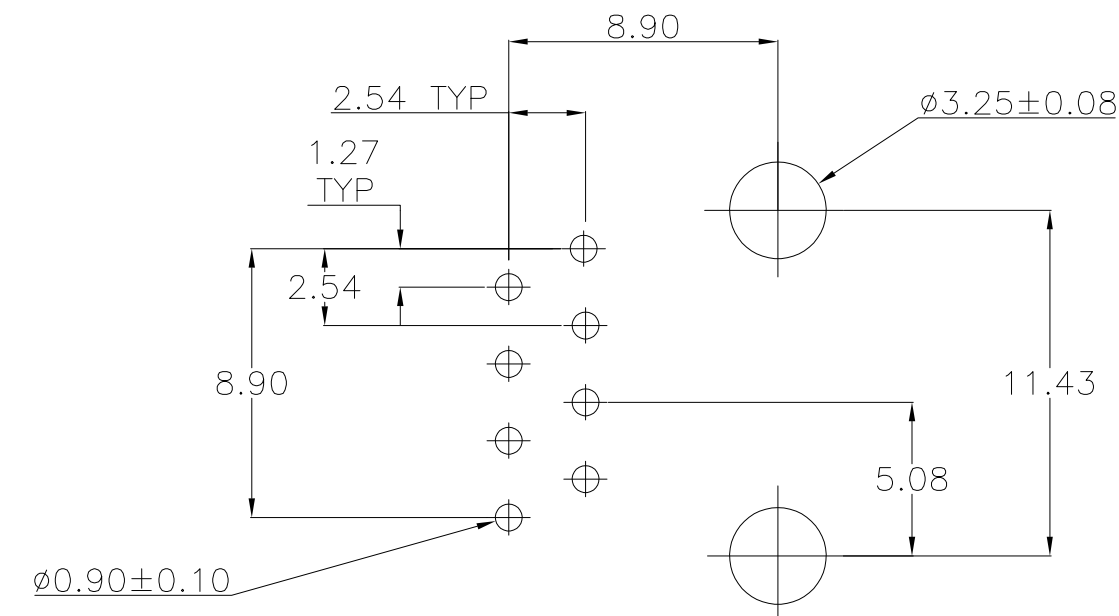
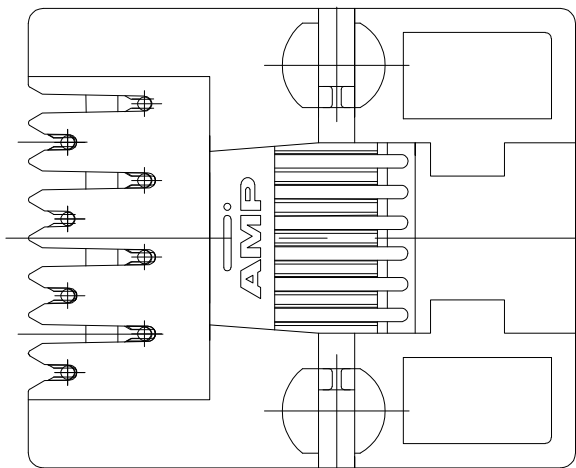
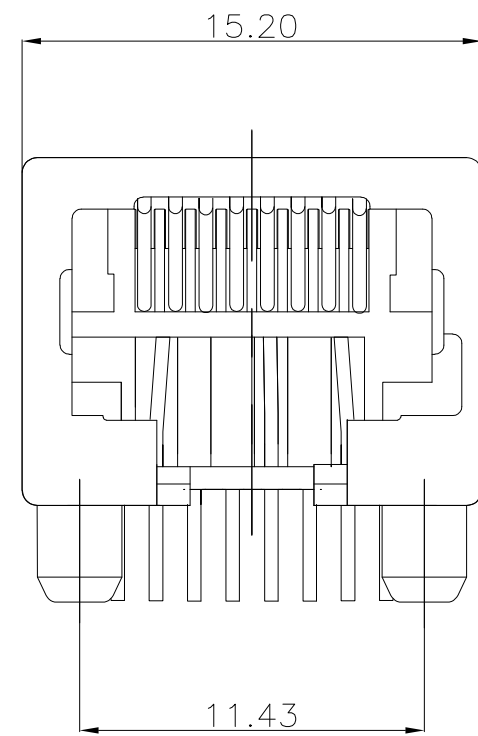
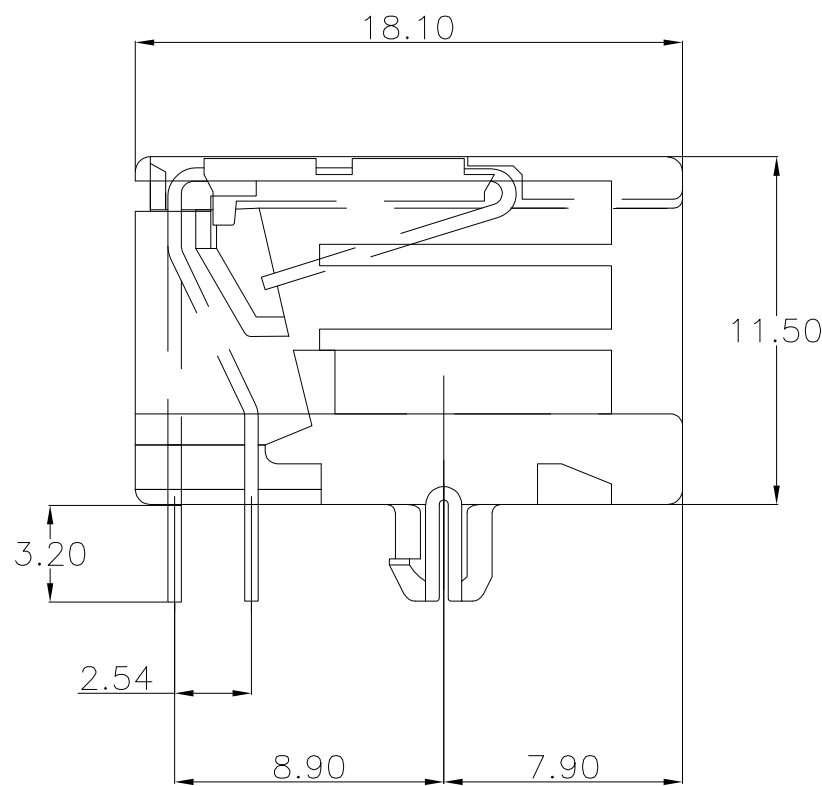
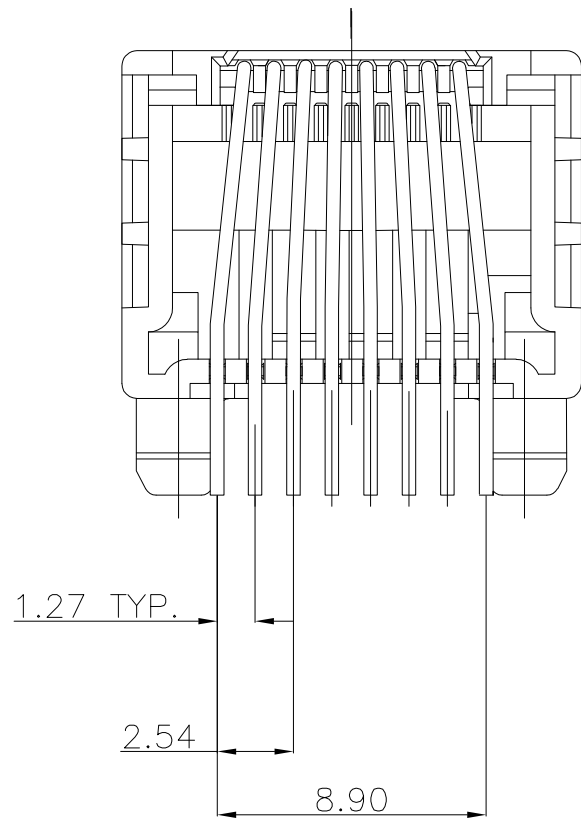
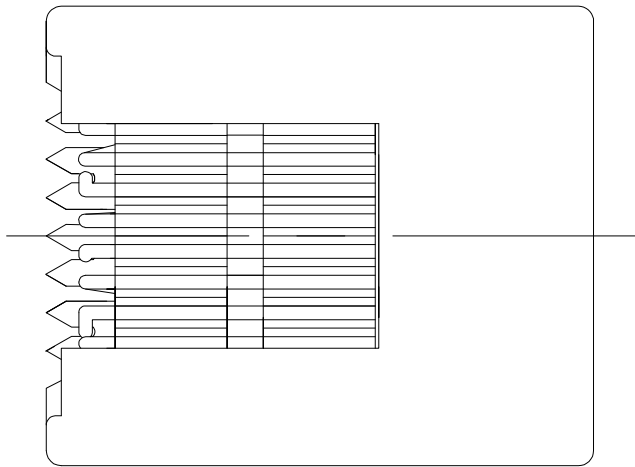


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
IR	—						
			L	ECR-10-020218	21JUN2011	PS	RRP

NOTES:

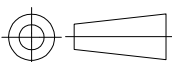
1. FOR APPLICATION INFORMATION SEE SPEC. 114-19019.
2. FOR PERFORMANCE REQUIREMENTS SEE SPEC. 108-19064.
3. TOLERANCES UNLESS OTHERWISE SPECIFIED: ± 0.15 .

 FOR THIS PACKAGING METHOD THE TRUE POSITION OF THE SOLDER TINES IS NOT GUARANTEED.



PRINTED CIRCUIT BOARD LAYOUT
VIEW SHOWN IS CIRCUIT (NONCOMPONENT) SIDE OF BOARD.
PRINTED CIRCUIT BOARD THICKNESS: 1.6 mm NOMINAL.
TOLERANCES UNLESS OTHERWISE SPECIFIED:

41000 PIECES BULK PACKAGED	8 POS./ 8 CONTACTS	OVERALL: Ni 1.27µm MIN. ALL OVER THE CONTACTS	HOUSING COLOR BLACK: PBT, UL 94V-0 CONTACT INSERT: PBT, UL 94V-0 CONTACTS: Ph BRONZE	2-215878-1	
TAPE MOUNTED 700 PCS./REEL		MATING ZONE: PLATING CONFIRMS TO PRODUCT REQUIREMENTS AS PER SPECIFICATION 108-19064		215878-1	
PACKAGING	REMARKS	FINISH	MATERIAL	ORDER NUMBER	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 15NOV88 C.A.STERKEN		TE Connectivity		
		CHK W.BRUMMANS				
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME		
		APVD L.V.SOEST		MODULAR JACK, 8 POS. 90 DEG LOW PROFILE FOR PRINTED CIRCUIT BOARD		
		PRODUCT SPEC 108-19064				
		APPLICATION SPEC 114-19019				
		MATERIAL		FINISH		RESTRICTED TO
SEE NOTES		SEE NOTES		SIZE A2	CAGE CODE 00779	DRAWING NO C-215878
		CUSTOMER DRAWING		SCALE —	SHEET 1 of 1	REV L